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	Filing Date		2006-06-07		
	First Named Inventor Tetsu		tsuo Fujii		
	Art Unit		2815		
	Examiner Name	Jeron	ne Jackson Jr.		
	Attorney Docket Numb	er	G&C 30794.108-US-WO		

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	1	EP1296362	EP			2003-03-26	Sumitomo Electric Industries, Ltd.				
	2	EP1538680	EP			2005-06-08	Sumitomo Electric Industries, Ltd.				
	3	EP1329961	EP			2003-07-23	Kabushiki Kaisha T	oshiba			

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	4	JP2003332618	JP		2003-11-21	Mitsubishi Cable Ind Ltd					
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